

12V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
12V	$4.8 \text{m}\Omega$ @ V _{GS} = 4.5V	15A
120	$7.0 \text{m}\Omega$ @ V _{GS} = 2.5V	12A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- General Purpose Interfacing Switch
- Power Management Functions

Features

- 0.6mm Profile Ideal for Low-Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Low On-Resistance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part.
 A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

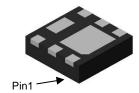
Mechanical Data

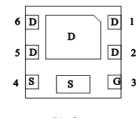
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.007 grams (Approximate)

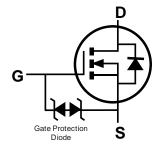
U-DFN2020-6 (Type F)











Top View

Bottom View

Pin Out Bottom View

Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1004UFDF-7	U-DFN2020-6 (Type F)	3,000/Tape & Reel
DMN1004UFDF-13	U-DFN2020-6 (Type F)	10.000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site 1



4U = Product Type Marking Code YM = Date Code Marking Y = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Kev

Year	2016		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	D		_	J	K	Г	М	N	0	Р	R	S
											l .	l .
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



4U = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 1 = 2021) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2016	 2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	6	 1	2	3	4	5	6	7	8	9	0

Week	1-26	27-52	53
Code	A-Z	a-z	Z

	Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Ī	Code	T	U	V	W	X	Y	Z



Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	12	V		
Gate-Source Voltage	Vgss	±8	V		
Continuous Drain Current (Note 6) VGS = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lo	15 12	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%	(a)		lом	70	Α
Maximum Body Diode Continuous Current (Note 6)			Is	3	Α
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	34	А		
Avalanche Energy (Note 7) L = 0.1mH			Eas	55	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	167	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	72	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	22	C/VV	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	12	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	_	1	μA	$V_{DS} = 9.6V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	0.3	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance		_	4.1	4.8	~ 0	V _G S = 4.5V, I _D = 15A	
Static Drain-Source On-Resistance	RDS(ON)	_	4.5	7.0	mΩ	Vgs = 2.5V, ID = 10A	
Diode Forward Voltage	V_{SD}		0.6	1.2	V	$V_{GS} = 0V, I_{S} = 3.2A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	CISS		2,385	_	pF	V 9V V 9V	
Output Capacitance	Coss	_	678	_	pF	V _{DS} = 6V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{RSS}	_	520	_	pF	T = T.OIVIHZ	
Gate Resistance	R _G	_	2.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	26	_	nC		
Total Gate Charge (V _{GS} = 10V)	Q _G	_	47	_	nC	\/	
Gate-Source Charge	Qgs	_	2.8	_	nC	$V_{DS} = 6V, I_{D} = 10A$	
Gate-Drain Charge	Q _{GD}	_	5.3	_	nC		
Turn-On Delay Time	td(ON)	_	5.3	_	ns		
Turn-On Rise Time	tR	_	10.7	_	ns	$V_{DS} = 6V, I_{D} = 5.0A$	
Turn-Off Delay Time	t _{D(OFF)}		31.6	_	ns	$V_{GS} = 4.5V, R_{G} = 1.0\Omega$	
Turn-Off Fall Time	tF	_	16.9	_	ns		
Reverse Recovery Time	trr		24.3	_	ns	1 0 0 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	
Reverse Recovery Charge	Q _{RR}		7.4	_	nC	I _F = 2.0A, di/dt = 100A/μs	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
- 7. IAS and EAS ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.
- Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



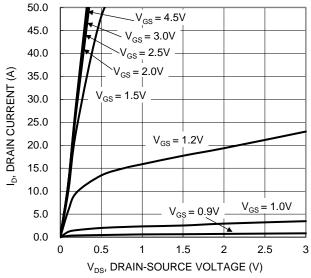


Figure 1. Typical Output Characteristic

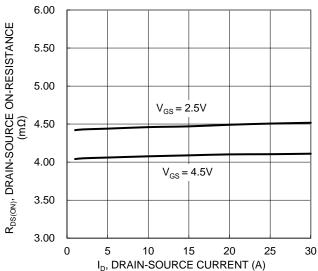


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

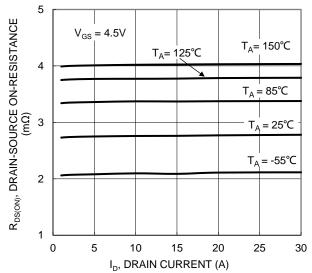


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

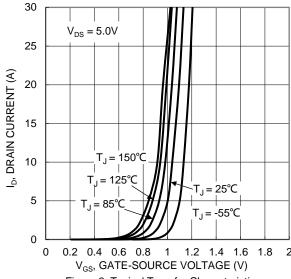


Figure 2. Typical Transfer Characteristic

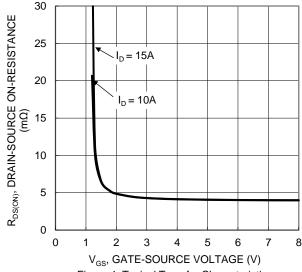


Figure 4. Typical Transfer Characteristic

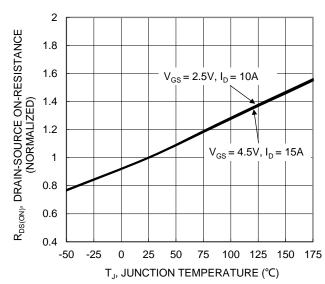
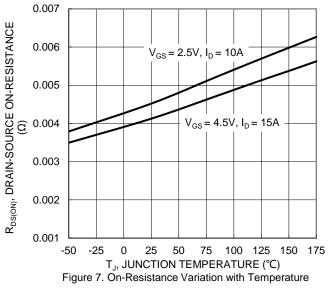
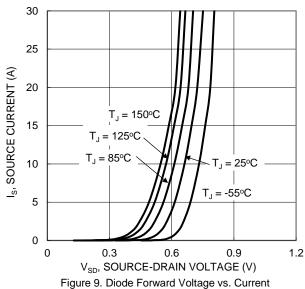


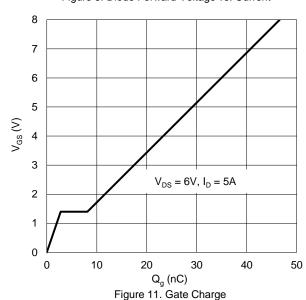
Figure 6. On-Resistance Variation with Temperature











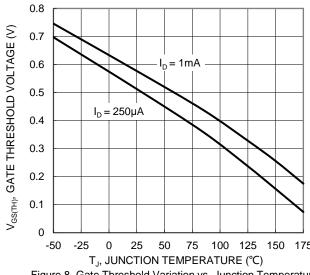
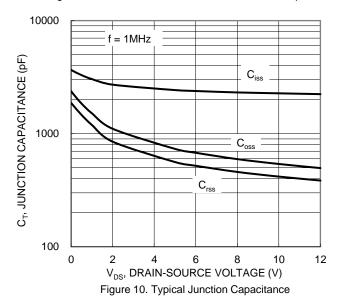
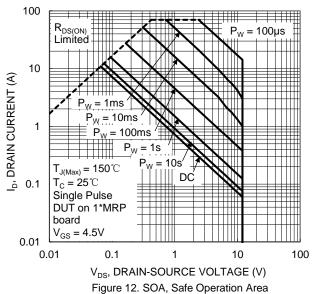


Figure 8. Gate Threshold Variation vs. Junction Temperature







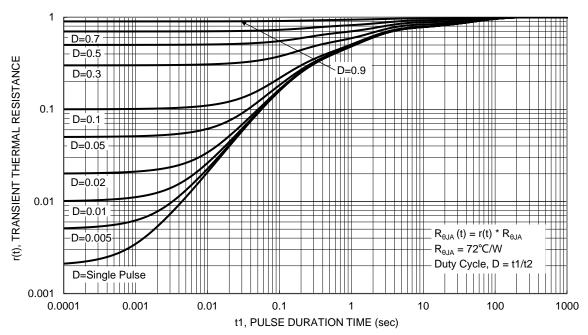


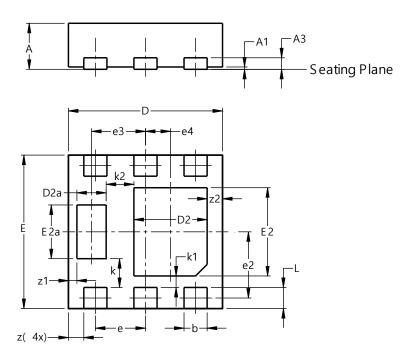
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)

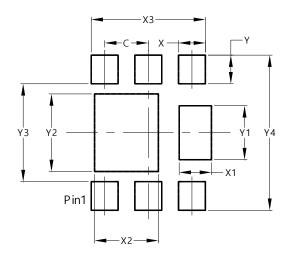


	U-DFN2020-6							
(Type F)								
Dim	Min	Max	Тур					
Α	0.57	0.63	0.60					
A1	0.00	0.03						
A3	-	0.						
b	0.25	0.35	0.30					
D	1.95	2.05	2.00					
D2	0.85							
D2a	0.33							
Е	1.95	1.95 2.05 2.0						
E2	1.05	1.25	1.15					
E2a	0.65	0.75	0.70					
е	(0.65 BS	C					
e2	C	.863 BS	OS					
е3		0.70 BS						
e4	C	.325 BS	OS					
k	(0.37 BS	С					
k1	(0.15 BS	С					
k2		0.36 BS						
L	0.225 0.325 0.275							
Z	0.20 BSC							
z 1	C	.110 BS	SC					
z2	(0.20 BS	С					
All D	imens	ions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



Dimensions	Value (in mm)		
С	0.650		
X	0.400		
X1	0.480		
X2	0.950		
Х3	1.700		
Υ	0.425		
Y1	0.800		
Y2	1.150		
Y3	1.450		
Y4	2.300		



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